

SPACER FOR PRINTED BOARD

Patent Number: JP2076297
Publication date: 1990-03-15
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Requested Patent: ☐ JP2076297
Application JP19880226615 19880912
Priority Number(s):
IPC Classification: H05K7/14 ; H05K1/14
EC Classification:
Equivalents:

Abstract

PURPOSE: To improve assembly and operability by performing coupling and separation of fellow spacers in a state, where a printed board is set at a prescribed height while making the printed board to hold spacers.
CONSTITUTION: A spacer 1 is previously pressed to the printed boards 3' and 3" to be mounted in piles. In case the printed board 3' is piled to a printed board 3, the spacer can move upward by the surplus length 1f of a latch part so that the male and female engagement parts are locked after the printed board 3' is placed in a prescribed position. Further similarly, in case the printed board 3" is piled to the printed board 3', the male and female engagement parts of the spacer 1 are locked in a state where the printed board 3" is placed in a prescribed position. Further, when the printed board is to be dismounted, the engagement part of the spacer 1 is dismounted for being followed by dismounting the printed board. Thereby, assembly and operability in mounting and dismounting of the printed board 3 is improved.

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